

Fast IGBT in NPT-technology

- 75% lower *E*_{off} compared to previous generation combined with low conduction losses
- \bullet Short circuit withstand time 10 μs
- Designed for:
 - Motor controls
 - Inverter
- NPT-Technology for 600V applications offers:
 - very tight parameter distribution
 - high ruggedness, temperature stable behaviour
 parallel switching capability
- Pb-free lead plating; RoHS compliant
- Qualified according to JEDEC² for target applications
- Complete product spectrum and PSpice Models : http://www.infineon.com/igbt/

Туре	V _{CE}	I _c	V _{CE(sat)150°C}	Tj	Marking	Package
SGP02N60	600V	2A	2.2V	150°C	G10N60	PG-TO-220-3-1
SGD02N60	600V	2A	2.2V	150°C	G10N60	PG-TO-252-3-11

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CE}	600	V
DC collector current	I _C		А
$T_{\rm C} = 25^{\circ}{\rm C}$		6.0	
$T_{\rm C} = 100^{\circ}{\rm C}$		2.9	
Pulsed collector current, t_p limited by T_{jmax}	<i>I</i> _{Cpuls}	12	
Turn off safe operating area	-	12	
$V_{CE} \le 600V, \ T_j \le 150^{\circ}C$			
Gate-emitter voltage	V _{GE}	±20	V
Avalanche energy, single pulse	E _{AS}	13	mJ
$I_{\rm C}$ = 2 A, $V_{\rm CC}$ = 50 V, $R_{\rm GE}$ = 25 Ω ,			
start at $T_j = 25^{\circ}C$			
Short circuit withstand time ¹⁾	t _{sc}	10	μs
$V_{\rm GE}$ = 15V, $V_{\rm CC} \le 600$ V, $T_{\rm j} \le 150^{\circ}$ C			
Power dissipation	P _{tot}	30	W
$T_{\rm C} = 25^{\circ}{\rm C}$			
Operating junction and storage temperature	$T_{ m j}$, $T_{ m stg}$	-55+150	°C
Soldering temperature,	Ts	260	
wavesoldering, 1.6mm (0.063 in.) from case for 10s			

² J-STD-020 and JESD-022

¹⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.







Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				
IGBT thermal resistance,	$R_{ m thJC}$		4.2	K/W
junction – case				
Thermal resistance,	$R_{ m thJA}$	PG-TO-220-3-1	62	
junction – ambient				
SMD version, device on PCB ¹⁾	$R_{ m thJA}$	PG-TO-252-3-1	50	

Electrical Characteristic, at T_i = 25 °C, unless otherwise specified

Parameter	Symbol	Conditions		Value		Unit
Farameter	Symbol	Conditions	min.	Тур.	max.	Onit
Static Characteristic						
Collector-emitter breakdown voltage	V _{(BR)CES}	$V_{\rm GE}$ =0V, $I_{\rm C}$ =500 μ A	600	-	-	V
Collector-emitter saturation voltage	V _{CE(sat)}	$V_{\rm GE}$ = 15V, $I_{\rm C}$ =2A				
		<i>T</i> _j =25°C	1.7	1.9	2.4	
		<i>T</i> _j =150°C	-	2.2	2.7	
Gate-emitter threshold voltage	V _{GE(th)}	$I_{\rm C} = 150 \mu {\rm A}, V_{\rm CE} = V_{\rm GE}$	3	4	5	
Zero gate voltage collector current	I _{CES}	$V_{\rm CE}$ =600V, $V_{\rm GE}$ =0V				μA
		<i>T</i> _i =25°C	-	-	20	
		<i>T</i> _j =150°C	-	-	250	
Gate-emitter leakage current	I _{GES}	$V_{\rm CE} = 0 V, V_{\rm GE} = 20 V$	-	-	100	nA
Transconductance	g _{fs}	V _{CE} =20V, <i>I</i> _C =2A	-	1.6	-	S
Dynamic Characteristic						
Input capacitance	Ciss	V _{CE} =25V,	-	142	170	pF
Output capacitance	Coss	V _{GE} =0V,	-	18	22	
Reverse transfer capacitance	Crss	f=1MHz	-	10	12	
Gate charge	Q _{Gate}	V _{CC} =480V, <i>I</i> _C =2A	-	14	18	nC
		V _{GE} =15V				
Internal emitter inductance	L _E		-	7	-	nH
measured 5mm (0.197 in.) from case						
Short circuit collector current ²⁾	I _{C(SC)}	V_{GE} =15V, t_{SC} ≤10µs V_{CC} ≤ 600V, T_j ≤ 150°C	-	20	-	A

¹⁾ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70μm thick) copper area for collector connection. PCB is vertical without blown air.
 ²⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



Switching Characteristic, Inductive Load, at Ti=25 °C

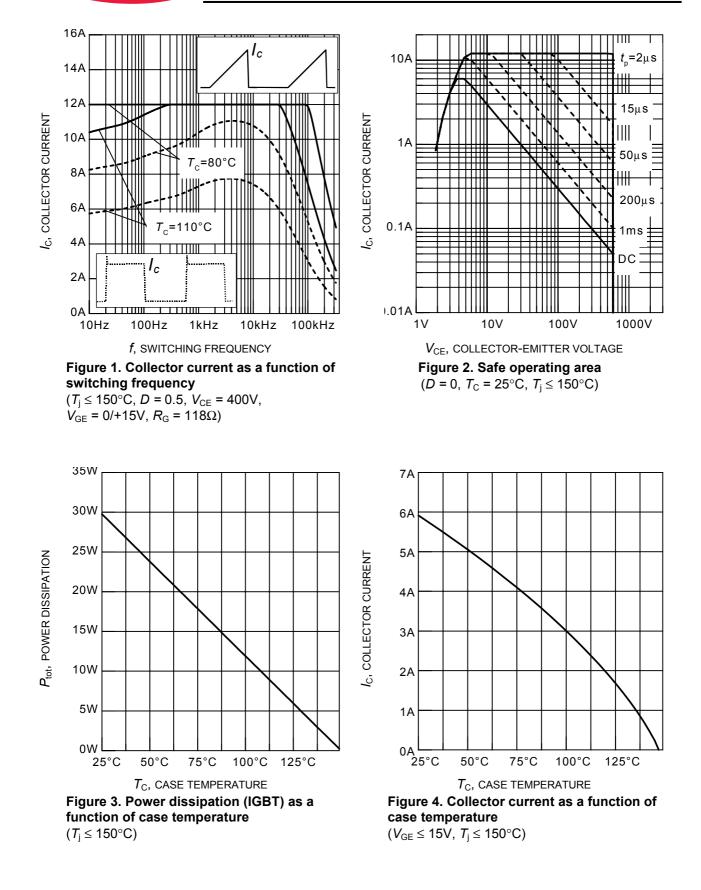
Parameter	Symbol	Conditions	Value			Unit
Farameter	Symbol	Conditions	min.	typ.	max.	
IGBT Characteristic						
Turn-on delay time	t _{d(on)}	<i>T</i> _j =25°C,	-	20	24	ns
Rise time	tr	V _{CC} =400V,I _C =2A, V _{GE} =0/15V,	-	13	16	
Turn-off delay time	$t_{d(off)}$	$R_{\rm G}$ =118 Ω ,	-	259	311	
Fall time	t _f	$L_{\sigma}^{(1)} = 180 \text{ nH},$	-	52	62	
Turn-on energy	Eon	$C_{\sigma}^{(1)} = 180 \text{ pF}$ Energy losses include	-	0.036	0.041	mJ
Turn-off energy	E _{off}	"tail" and diode	-	0.028	0.036	
Total switching energy	E _{ts}	reverse recovery.	-	0.064	0.078	

Switching Characteristic, Inductive Load, at T_i =150 °C

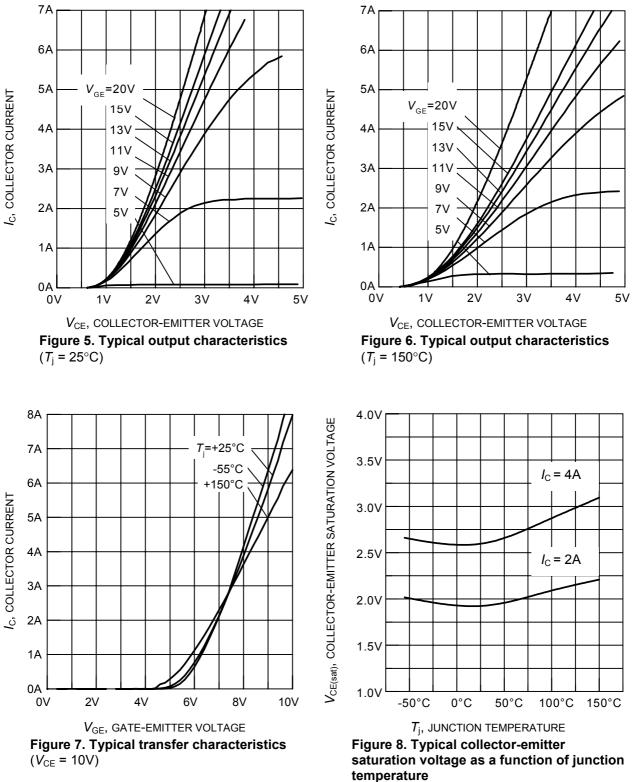
Parameter	Symbol	Conditions	Value			11
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t _{d(on)}	<i>T</i> _j =150°C,	-	20	24	ns
Rise time	tr	V _{CC} =400V, <i>I</i> _C =2A, V _{GE} =0/15V,	-	14	17]
Turn-off delay time	$t_{d(off)}$	$R_{\rm G}$ =118 Ω ,	-	287	344	1
Fall time	t _f	$L_{\sigma_{1}}^{(1)} = 180 \text{ nH},$	-	67	80	1
Turn-on energy	Eon	$C_{\sigma}^{(1)} = 180 \text{ pF}$ Energy losses include	-	0.054	0.062	mJ
Turn-off energy	E _{off}	"tail" and diode	-	0.043	0.056	1
Total switching energy	Ets	reverse recovery.	-	0.097	0.118	1

¹⁾ Leakage inductance L_{σ} and Stray capacity C_{σ} due to dynamic test circuit in Figure E.



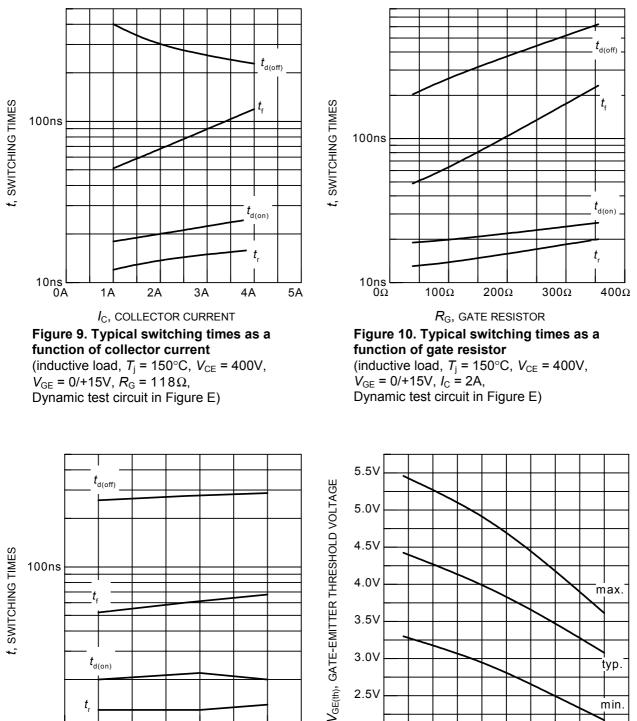


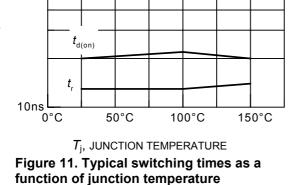




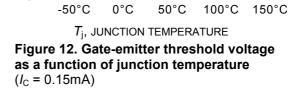
 $(V_{\rm GE} = 15V)$







(inductive load, $V_{CE} = 400V$, $V_{GE} = 0/+15V$, $I_{\rm C} = 2A, R_{\rm G} = 118\Omega,$ Dynamic test circuit in Figure E)



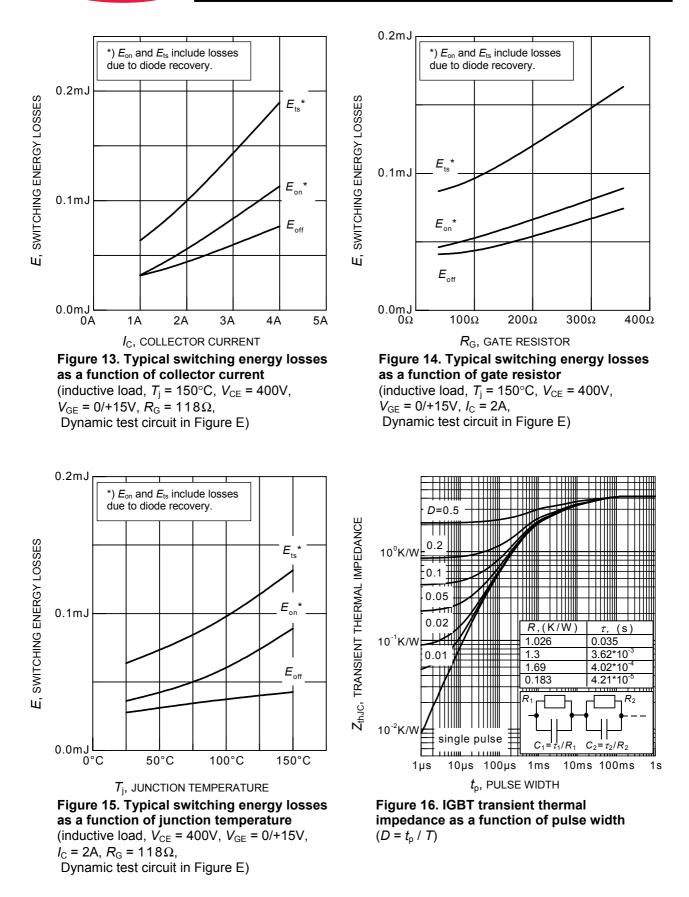
typ.

min.

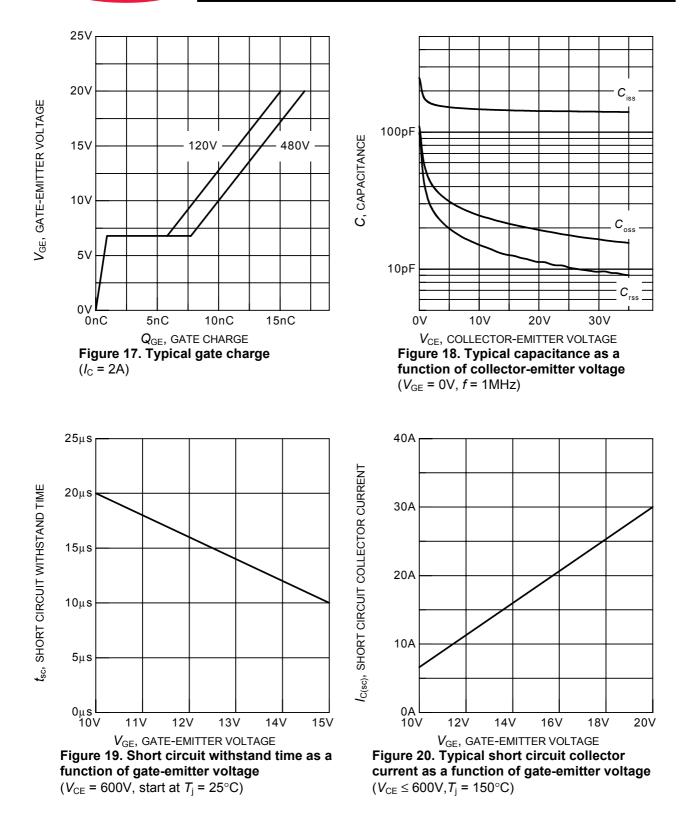
2.5V

2.0V

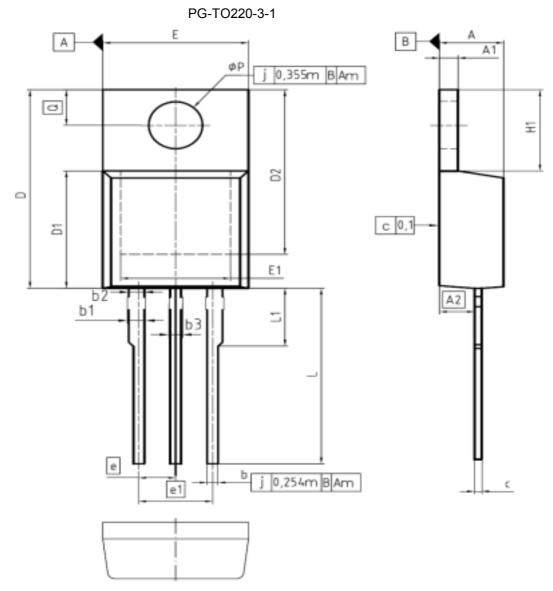




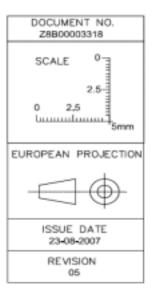




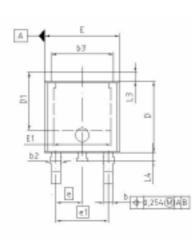


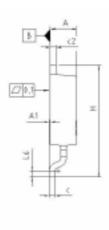


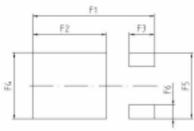
DIM	MILLIM	ETERS	INC	1ES
DIM	MIN	MAX	MIN	MAX
A	4.30	4.57	0.169	0.180
A1	1.17	1.40	0.046	0.055
A2	2.15	2.72	0.085	0.107
ь	0.65	0.86	0,026	0.034
ь1	0.95	1.40	0.037	0.055
ь2	0.95	1.15	0,037	0.045
ь3	0,65	1,15	0,026	0.045
с	0.33	0.60	0.013	0.024
D	14.81	15.95	0.583	0.628
D1	8.51	9.45	0,335	0.372
D2	12.19	13.10	0.480	0.516
E	9.70	10.36	0.382	0.408
E1	6,50	8,60	0,256	0.339
e	2.	54	0.100	
e1	5.	80	0.2	200
N		3		3
H1	5.90	6.90	0.232	0.272
L	13.00	14.00	0.512	0.551
L1	-	4.80	-	0.189
øP	3.60	3.89	0.142	0.153
0	2.60	3.00	0.102	0,118











DIM	MILLIM	ETERS	INC	HES
Dim	MIN	MAX	MIN	MAX
A	2.184	2.388	0.066	0.094
A1	0.000	0.150	0.000	0.008
b	0.635	0.889	0.025	0.035
b2	0.650	1.150	0.025	0.045
b3	5,004	5.500	0.197	0.217
0	0.460	0.580	0.018	0.023
62	0.460	0.980	0.018	0.039
D	5,969	6.223	0.235	0.245
D1	5,020	5.320	0.196	0.209
E	6,400	6.731	0.252	0.265
E1	4,900	5.100	0.193	0.201
	2.2	86	0.0	990
e1	4,5	72	0.1	80
N	3		3	
н	9,400	10.084	0.370	0.397
L3	0.900	1.118	0.035	0.044
L4	0.850	1.016	0.026	0.040
L6	0.510	0.685	0.020	0.027
F1	10.500	10.700	0.413	0.421
F2	6.300	6.500	0.248	0.256
F3	2.100	2.300	0.063	0.091
F4	5.700	5.900	0.224	0.232
F5	5.860	5.880	0.222	0.231
F6	1.100	1.300	0.043	0.051

PG-TO252-3-11



Figure B. Definition of switching losses

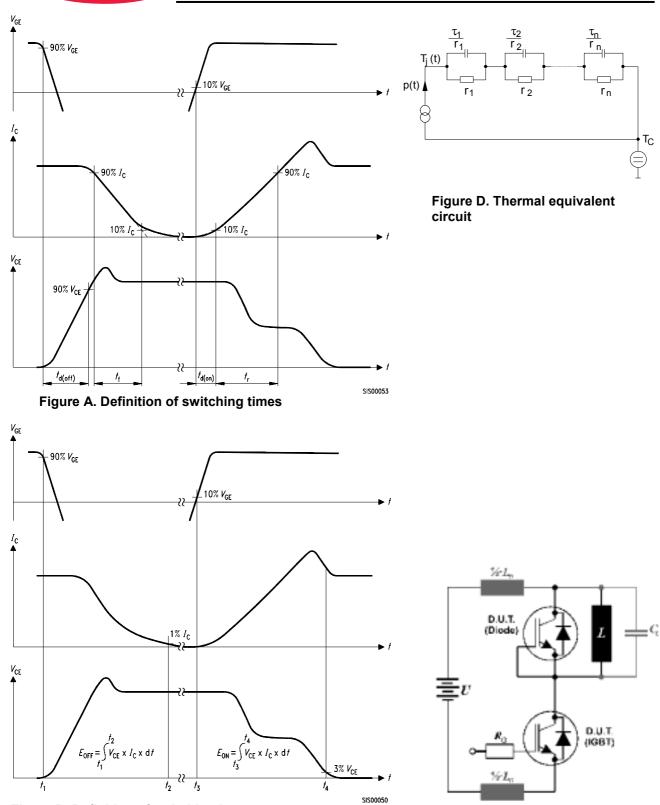


Figure E. Dynamic test circuit Leakage inductance L_{σ} =180nH and Stray capacity C_{σ} =180pF.



Edition 2006-01

Published by Infineon Technologies AG 81726 München, Germany

© Infineon Technologies AG 9/12/07. All Rights Reserved.

Attention please!

The information given in this data sheet shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie"). With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (**www.infineon.com**).

Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Infineon: SGD02N60